

1N8034-GA

High Temperature Silicon Carbide Power Schottky Diode

Features

- 650 V Schottky rectifier
- 210 °C maximum operating temperature
- Electrically isolated base-plate
- Zero reverse recovery charge
- Superior surge current capability
- Positive temperature coefficient of V_F
- Temperature independent switching behavior
- Lowest figure of merit Q_C/I_F
- Available screened to Mil-PRF-19500

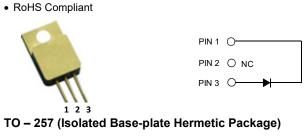
Advantages

- High temperature operation
- Improved circuit efficiency (Lower overall cost)
- · Low switching losses
- Ease of paralleling devices without thermal runaway
- Smaller heat sink requirements
- Industry's lowest reverse recovery charge
- Industry's lowest device capacitance
- Ideal for output switching of power supplies
- Best in class reverse leakage current at operating temperature

Maximum Ratings at T_j = 210 °C, unless otherwise specified

V_{RRM} = 650 V $I_{F(Tc=25^{\circ}C)}$ = 30 A Q_{C} = 66 nC

Package



Applications

- Down Hole Oil Drilling
- Geothermal Instrumentation
- Solenoid Actuators
- General Purpose High-Temperature Switching
- Amplifiers
- Solar Inverters
- Switched-Mode Power Supply (SMPS)
- Power Factor Correction (PFC)

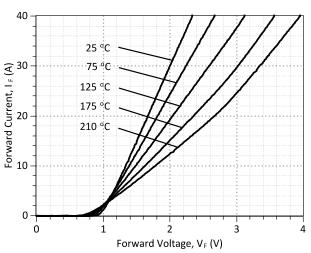
Parameter	Symbol	Conditions	Values	Unit
Repetitive peak reverse voltage	V _{RRM}		650	V
Continuous forward current	I _F	T _C = 25 °C	30	А
Continuous forward current	I _F	T _c ≤ 190 °C	9.4	А
RMS forward current	I _{F(RMS)}	T _C ≤ 190 °C	16	А
Surge non-repetitive forward current, Half Sine Nave	I _{F,SM}	T_{C} = 25 °C, t_{P} = 10 ms	140	А
Non-repetitive peak forward current	I _{F,max}	T _C = 25 °C, t _P = 10 μs	650	А
² t value	∫i ² dt	T _C = 25 °C, t _P = 10 ms	98	A ² S
Power dissipation	P _{tot}	T _C = 25 °C	208	W
Operating and storage temperature	T _j , T _{stg}		-55 to 210	°C

Electrical Characteristics at T_j = 210 °C, unless otherwise specified

Deveryorken	Cumple of	Conditions -		Values		11	
Parameter	Symbol			min.	typ.	max.	Unit
Diode forward voltage	V _F	I _F = 10 A, T _j = 25 °C		1.3		V	
	VF	I _F = 10 A, T _j = 210 °C			1.8		v
Reverse current		V _R = 650 V, T _j = 25 °C		1	5		
	IR	V _R = 650 V, T _j = 210 °C			50	200	μA
Total capacitive charge	Qc	l _F ≤ I _{F,MAX} dI _F /dt = 200 A/μs	V _R = 400 V		66		nC
Switching time	ts	$T_i = 210 \text{ °C}$	V _R = 400 V		< 49		ns
Total capacitance		V _R = 1 V, f = 1 MHz	T _j = 25 °C		1107		
	С	V _R = 400 V, f = 1 MHz, T _i = 25 °C			103		pF
		V _R = 650 V, f = 1 MH	z, T _i = 25 °C		99		

Thermal resistance, junction - case	R _{thJC}	1.08	°C/W
Mechanical Properties			
Mounting torque	М	0.6	Nm

1N8034-GA



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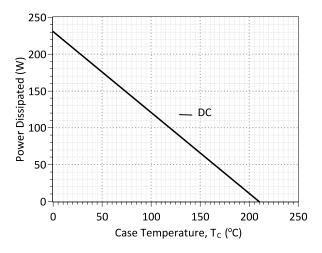
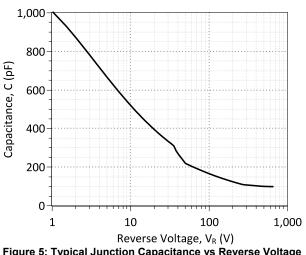
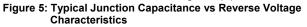


Figure 3: Power Derating Curve





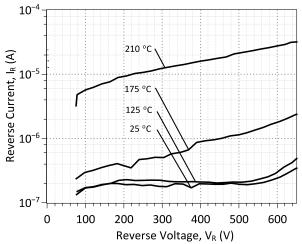


Figure 2: Typical Reverse Characteristics

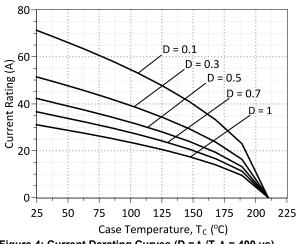
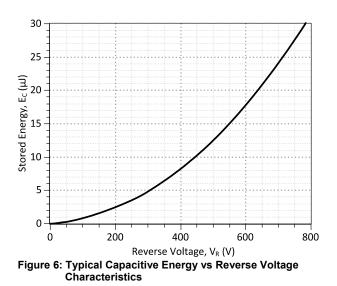


Figure 4: Current Derating Curves (D = t_p/T , t_p = 400 µs) (Considering worst case Z_{th} conditions)



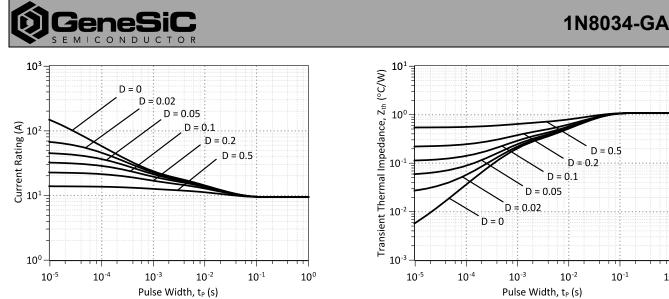


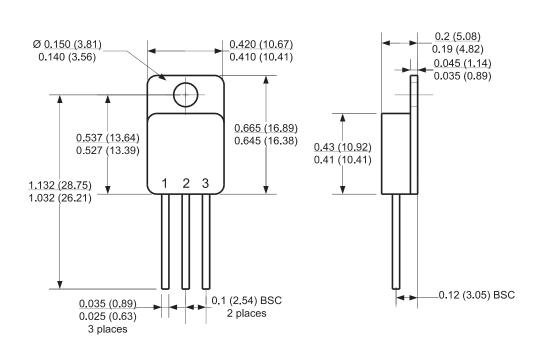
Figure 7: Current vs Pulse Duration Curves at T_c = 190 °C

TO-257



PACKAGE OUTLINE

Package Dimensions:



NOTE

- 1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
- 2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS

10⁰



Revision History				
Date	Revision	Comments	Supersedes	
2014/08/26	1	Updated Electrical Characteristics		
2012/04/24	0	Initial release		

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SPICE Model Parameters

Copy the following code into a SPICE software program for simulation of the 1N8034-GA device.

```
*
     MODEL OF GeneSiC Semiconductor Inc.
*
*
     $Revision: 1.0
                                $
*
     $Date: 05-SEP-2013
                                $
*
*
    GeneSiC Semiconductor Inc.
*
     43670 Trade Center Place Ste. 155
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     Dulles, VA 20166
*
    http://www.genesicsemi.com/index.php/hit-sic/schottky
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*
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     ALL RIGHTS RESERVED
* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
* PARTICULAR PURPOSE."
* Models accurate up to 2 times rated drain current.
* Start of 1N8034-GA SPICE Model
.SUBCKT 1N8034 ANODE KATHODE
D1 ANODE KATHODE 1N8034 25C; Call the Schottky Diode Model
D2 ANODE KATHODE 1N8034 PIN; Call the PiN Diode Model
.MODEL 1N8034 25C D
+ IS
     8.46E-17
                          RS
                                     0.0319
                                     1000
+ N
         1
                          IKF
+ EG
         1.2
                         XTI
                                     3
+ TRS1
         0.0038
                         TRS2
                                    3.00E-05
         1.26E-09
                         VJ
+ CJO
                                     0.438
         1.5278
                                     0.5
+ M
                         FC
+ TT
         1.00E-10
                         BV
                                     650
         1.00E-03
                          VPK
                                     650
+ IBV
         20
+ IAVE
                          TYPE
                                     SiC Schottky
      GeneSiC_Semiconductor
+ MFG
.MODEL 1N8034 PIN D
+ IS 2.77E-10
                         RS
                                     0.086693
+ N
          3.3505
                          IKF
                                     3.67E-06
+ EG
          3.23
                         XTI
                                     -10
+ FC
         0.5
                         TT
                                     Ω
+ BV
                         IBV
         650
                                    1.00E-03
         650
                                    20
+ VPK
                          IAVE
+ TYPE
          SiC PiN
.ENDS
* End of 1N8034-GA SPICE Model
```